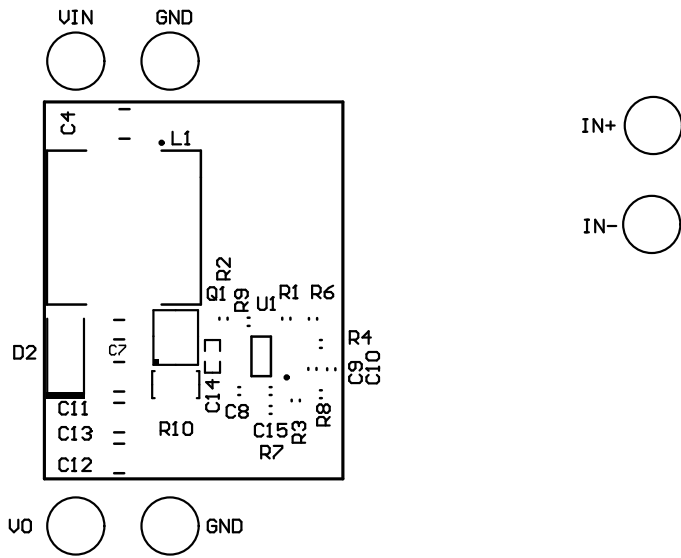
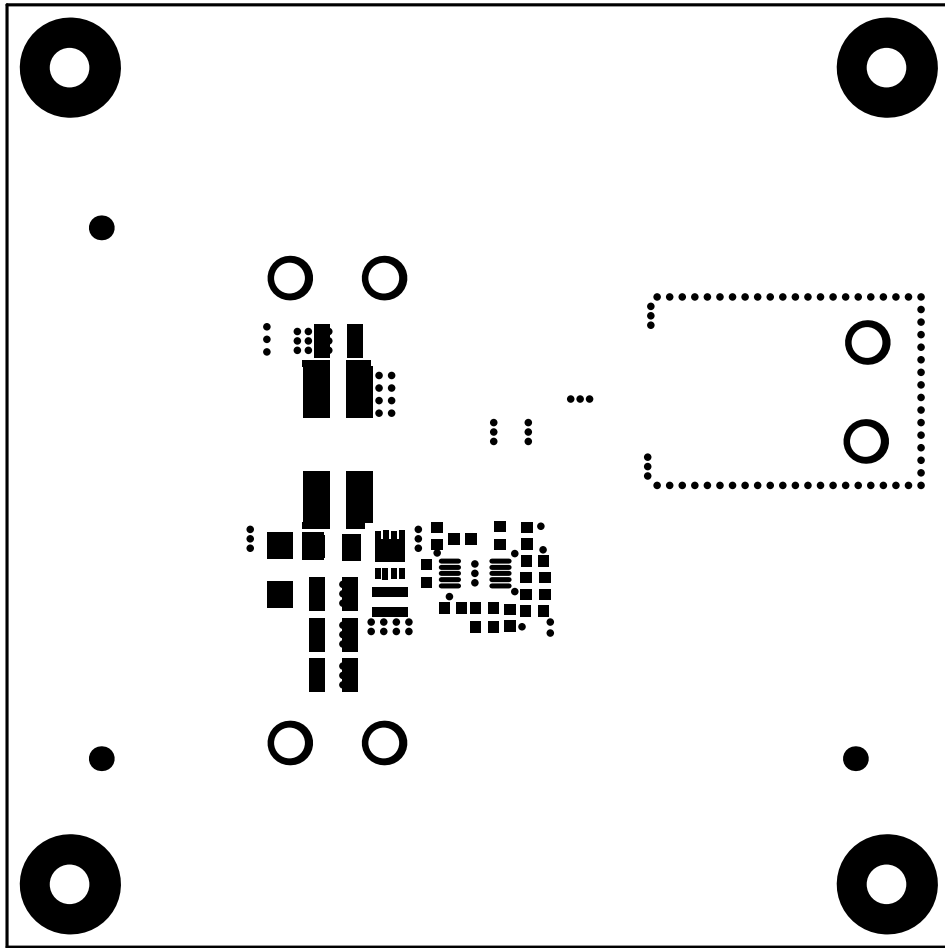

**TEXAS
INSTRUMENTS**
PMP10610



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10610	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: PMP10610		
PLOT NAME = Top Overlay	GENERATED : 5/8/2015	10:26:47 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE

BOARD #: PMP10610

REV: A

SUN REV: Not In VersionControl

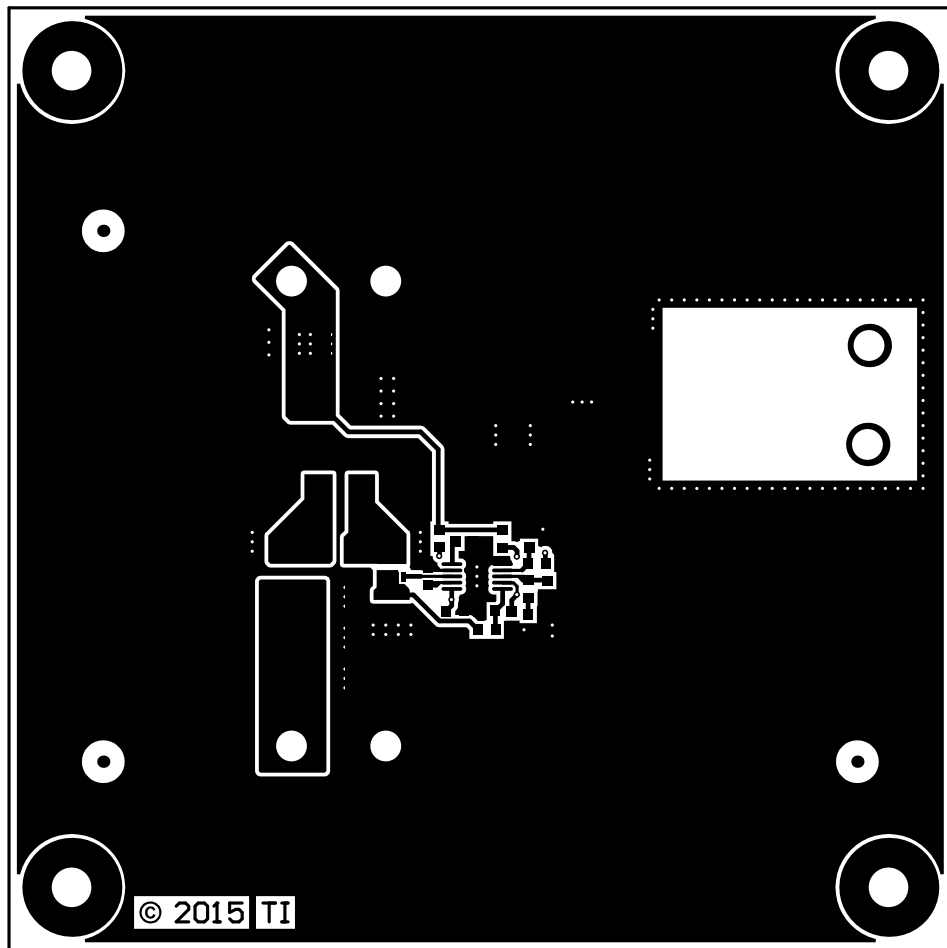
LAYER NAME = Top Solder

TID #: PMP10610

PLOT NAME = Top Solder Mask

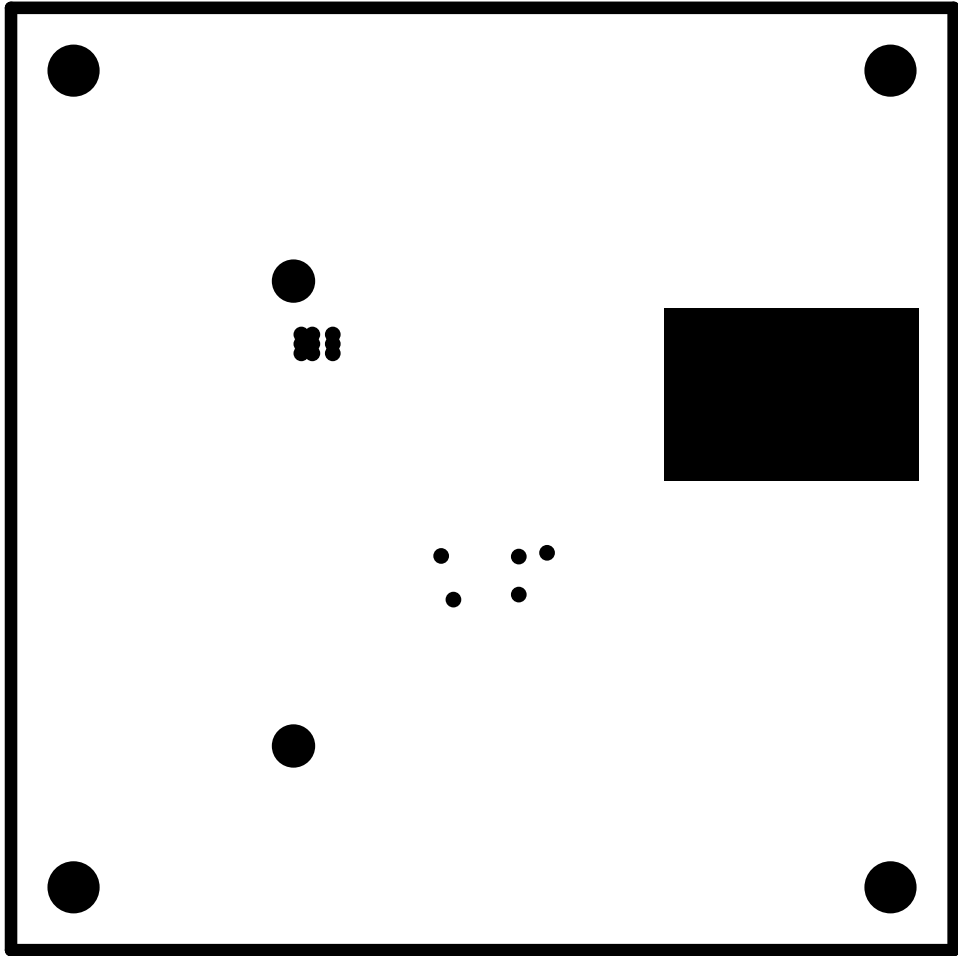
GENERATED : 5/8/2015 10:26:48 AM

TEXAS INSTRUMENTS

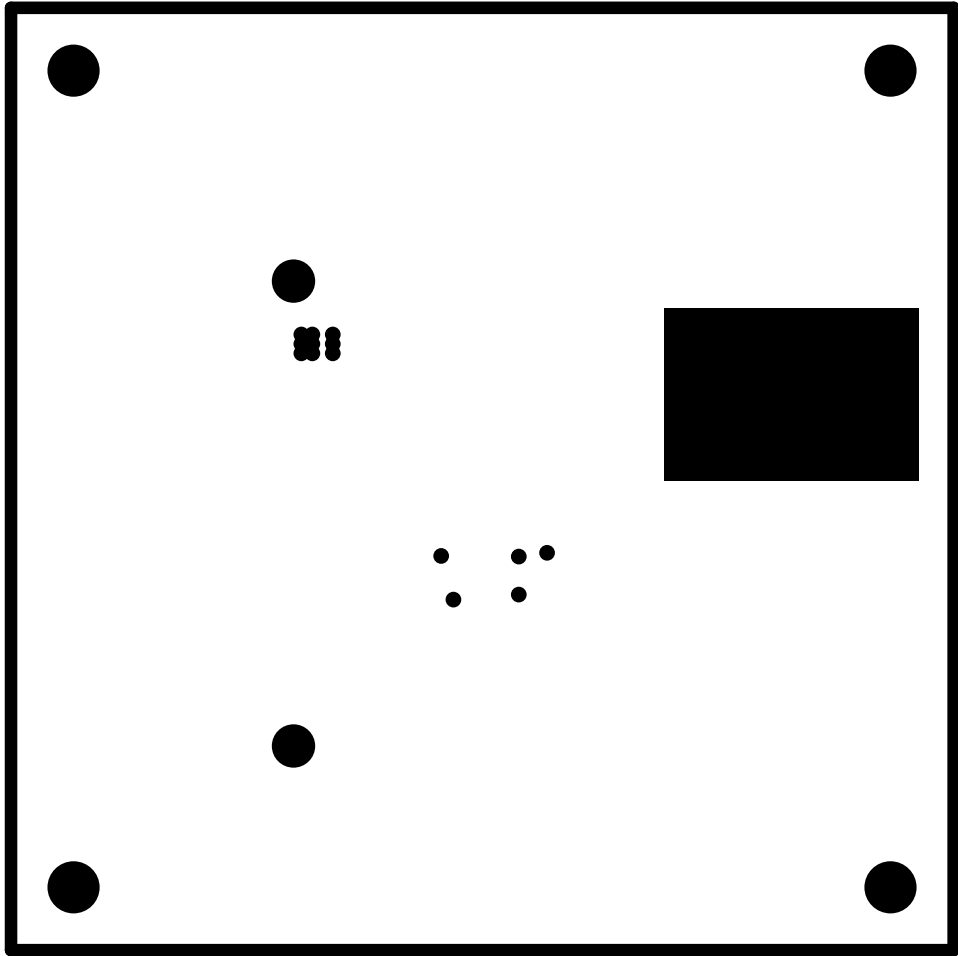


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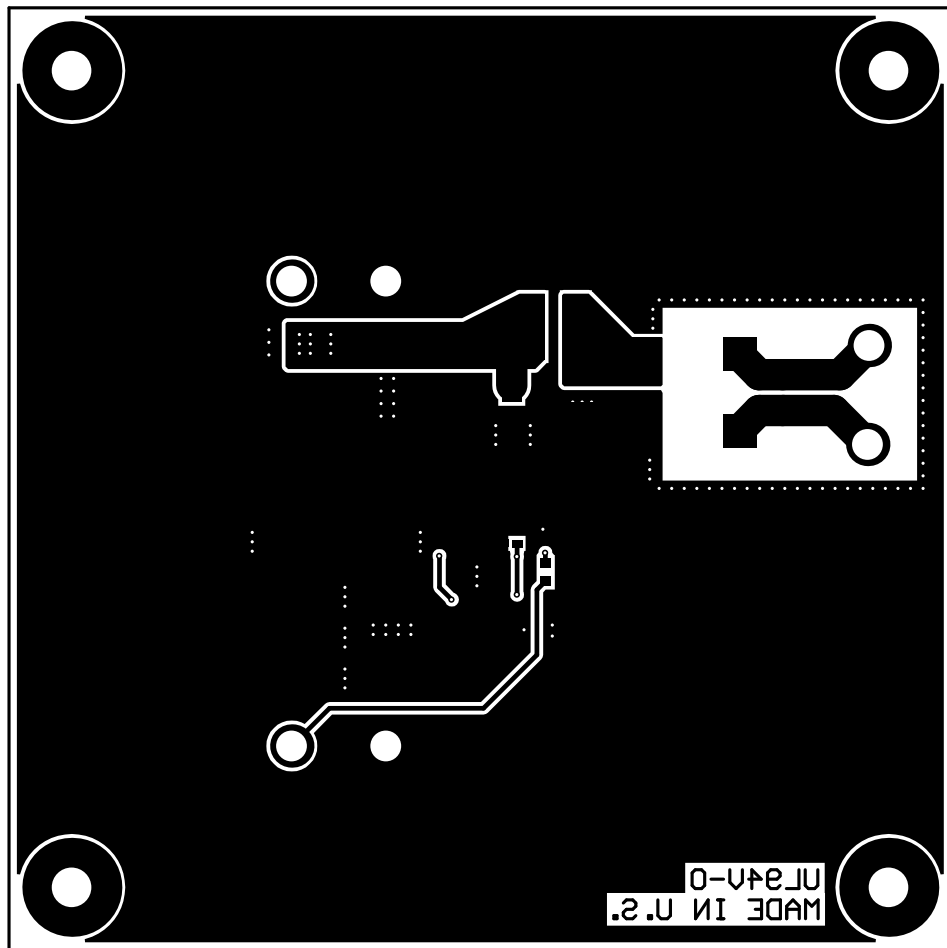
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10610	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: PMP10610		
PLOT NAME = Top Layer	GENERATED : 5/8/2015	10:26:49 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10610	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Mid Plane 1	TID #: PMP10610		
PLOT NAME = Mid Layer 1	GENERATED : 5/8/2015	10:26:49 AM	TEXAS INSTRUMENTS

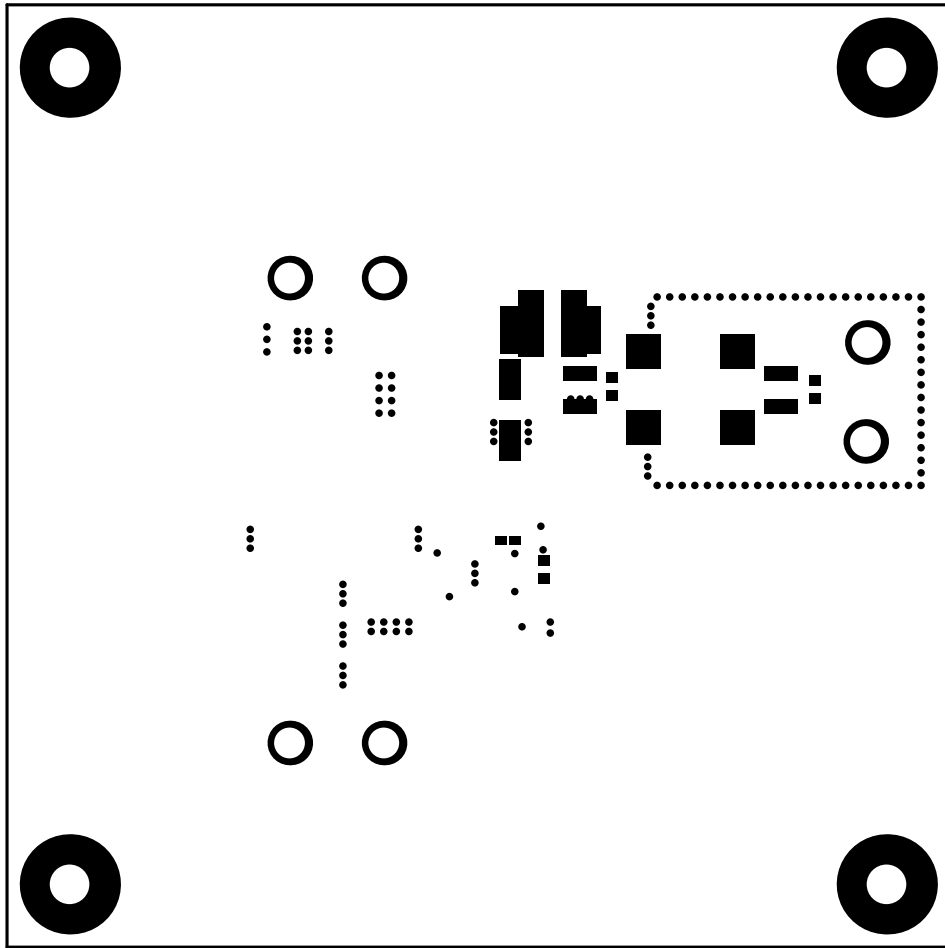


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10610	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Mid Plane 2	TID #: PMP10610		
PLOT NAME = Mid Layer 2	GENERATED : 5/8/2015	10:26:50 AM	TEXAS INSTRUMENTS



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ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10610	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: PMP10610		
PLOT NAME = Bottom Layer	GENERATED : 5/8/2015	10:26:51 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE

BOARD #: PMP10610

REV: A

SUN REV: Not In VersionControl

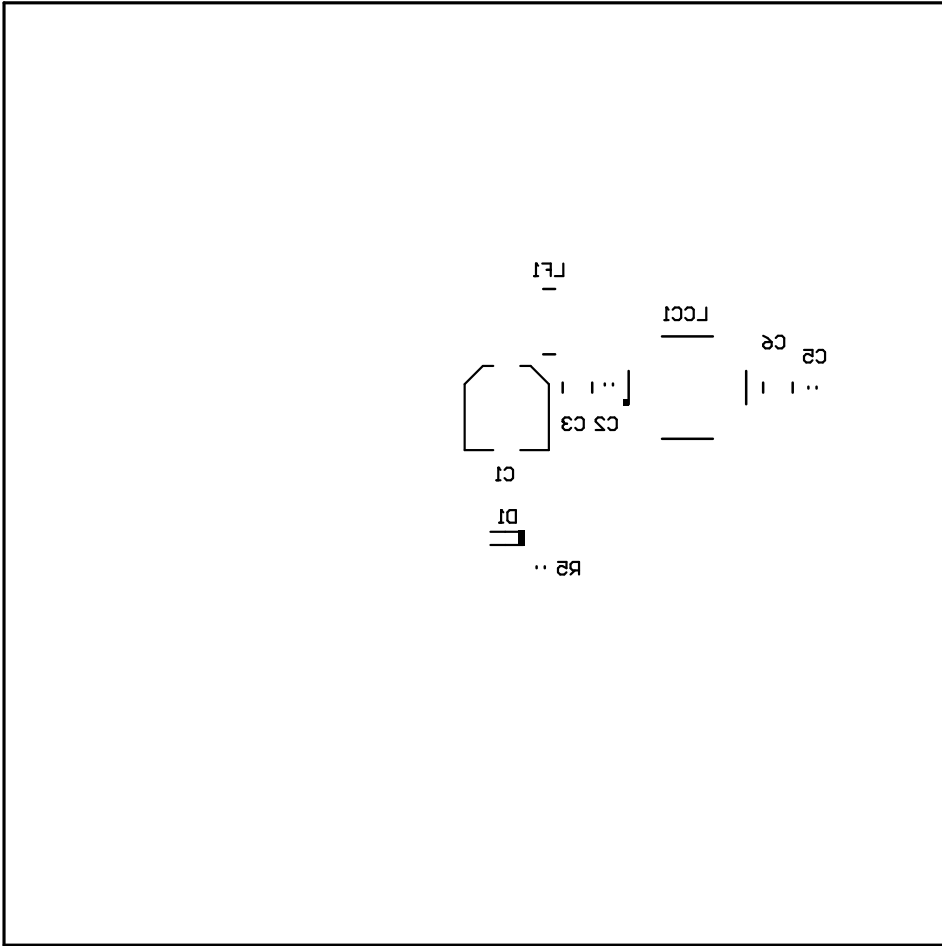
LAYER NAME = Bottom Solder

TID #: PMP10610

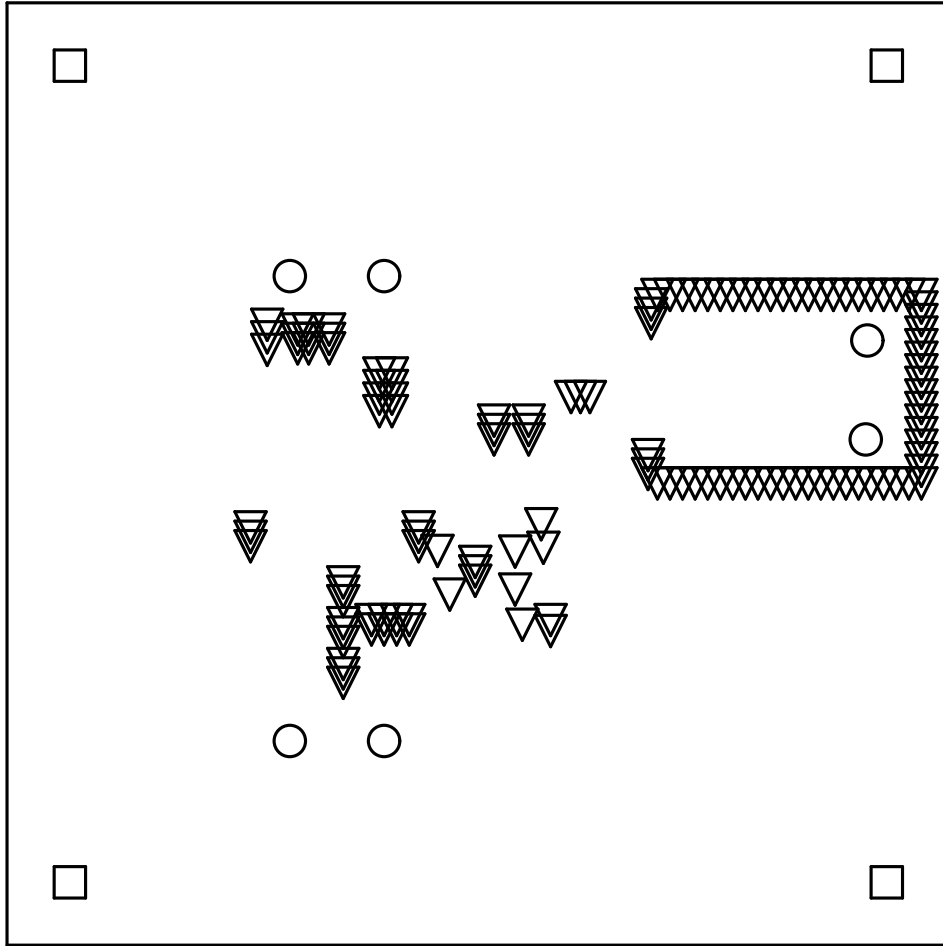
PLOT NAME = Bottom Solder Mask

GENERATED : 5/8/2015 10:26:51 AM

TEXAS INSTRUMENTS

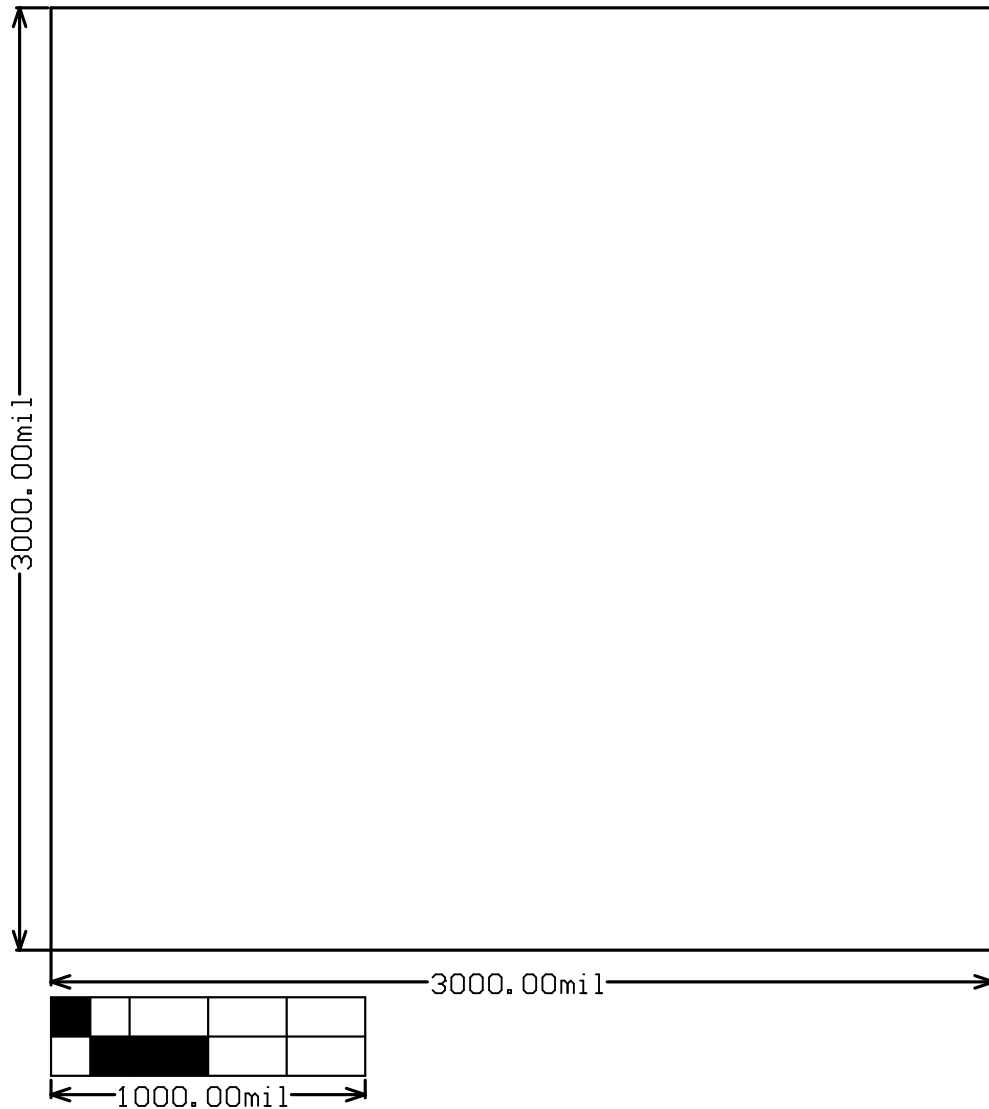


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10610	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: PMP10610		
PLOT NAME = Bottom Overlay	GENERATED : 5/8/2015	10:26:52 AM	TEXAS INSTRUMENTS



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
▽	128	10.00mil (0.254mm)	PTH	Round
○	6	98.43mil (2.500mm)	PTH	Round
□	4	125.98mil (3.200mm)	PTH	Round
	138 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10610	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: PMP10610		
PLOT NAME = Drill Drawing	GENERATED : 5/8/2015	10:26:53 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10610	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Mechanical 2	TID #: PMP10610		
PLOT NAME = Board Dimensions	GENERATED : 5/8/2015	10:26:53 AM	TEXAS INSTRUMENTS

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